

【注意】 2009年9月29日時点のプログラムです。
時間、報告順等は、変更の場合がございます。予め御了承下さい。
また、調整中につきましては、決まり次第随時更新いたします。

Date: Tuesday 29th, September 2009

MAP2009 Program

Wednesday 11th, November

13:00 ~ 13:05 Opening Remark

13:05 ~ 14:45 Session 1: Invited Talks

- 1-1 Present and Future of Digital Technology
Junshi Yamaguchi, President
NEC Electronics Corporation (JAPAN)
- 1-2 Current and Future Strategy of Semiconductor Industry in U.S.A.
Joseph Fjelstad
Microelectronics Packaging and Test Engineering Council (MEPTEC), (U.S.A.)
- 1-3 Adjustment
Vishal Pawar, Manager
Business Development & Strategy, Mahindra Engineering Services Ltd. (India)

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| Coffee Break |
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15:15 ~ 18:00 Session 2: Green Device

- 2-1 Adjustment (Organic Electro-Luminescence(OEL))
Kiyoshi Yoneda
Former Kodak (JAPAN)
- 2-2 Adjustment (LED)
Adjustment
Toshiba Corporation, Semiconductor Company (JAPAN)
- 2-3 Adjustment (Dye-Sensitized Solar Cell)
Tsukasa Yoshida, Associate Professor
Gifu University (JAPAN)
- 2-4 FC Bonding Technology for Optical Device
Fuhito Shinji
Toray Engineering Co.,Ltd. (JAPAN)
- 2-5 Adjustment
Adjustment
Mitsubishi Diamond Industries Co., Ltd. (JAPAN)

18:30 ~ 20:00 Reception Party @Argos

09:00 ~ 10:20 Session 3: Power Devices

- 3-1 Bridges from Chips to Packages
Tadaharu Minato
Power Device Works, Mitsubishi Electric Corporation (JAPAN)
- 3-2 Intelligent Power Module (IPM)
Gorab Majumdar
Power Device Works, Mitsubishi Electric Corporation (JAPAN)
- 3-3 Analyzation of Power supply and Grand Noise (Chip-Package-Substrate)
Toru Watanabe
Ansoft Japan K.K. (JAPAN)
- 3-4 Adjustment

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| Coffee Break |
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10:30 ~ 12:10 Session 4: 3D Integration

(Knowledge Cluster Initiative (The 2nd Stage) Expansion Program, The 5th Workshop)

- 4-1 Adjustment
Shinji Sasaguri
Panasonic Factory Solutions Co., Ltd. (JAPAN)
- 4-2 Impact of Glow Discharge Technology on Surface and Cross-Section Analysis
Toru Kaga, Vice President
Nanoscale Company (JAPAN)
- 4-3 Electrochemical process for through via/bump formation without CMP and lithographic processes
Jae-Ho Lee, Professor
Dept. of Materials Science and Engineering, Hongik University (KOREA)
- 4-4~4-6 Adjustment

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| Lunch Break |
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**13:00 ~ 13:20 Signing Ceremony of Memorandum of Understanding
between ASTSA & MEPTEC**

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| Coffee Break |
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13:30 ~ 14:50 Session 5: Taiwan Session

(Knowledge Cluster Initiative (The 2nd Stage) Expansion Program, The 5th Workshop)

- 5-1 Adjustment
Ian Yi-Jen Chan, Vice President & EOL General Director
Electronics and Optoelectronics Research Lab., Industrial Technology Research Institute (ITRI) (TAIWAN)

5-1~5-5 Adjustment

Coffee Break

15:30 ~ :17:10 Session 6: India Session

- 6-1 Adjustment(Invited Talk)
N Krishnan, Director General
Software Technology Parks of India (India)
- 6-2 Adjustment
Satoshi Yamada, Vice President
Asia Pacific Japan, eInfochips. Ltd. (India)
- 6-3~6-5 Adjutment

17:30 ~ 19:00 Session 7: Poster Session with Wines @Argos

Friday 13th, November

Excursion Schedule

- 07:30 JAL Resort Sea Hawk Hotel Fukuoka, 1F Robby
- 10:00 ~ 12:00 Tokyo Electron Kyushu Limited. Head Office, Goshi Plant
- 12:00 ~ 13:00 Lunch
- 13:30 ~ 15:30 Mitsubishi Electric Corporation, Power Device Works, Kumamoto Plant
- 17:30 Fukuoka Airport, Hakata Station

Poster Exhibition (Wednesday 11th - Thursday 12th)

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| Topcon Corporation (株式会社トプコン) | Kyushu Okano Electronics Co., Ltd. (株式会社九州岡野エレクトロニクス) | Adwels Co., Ltd. (株式会社アドウェルズ) |
| Walts Co., Ltd. (株式会社ウォルツ) | Fukudenshizai Co., Ltd. (福電資材株式会社) | Shintec Co., Ltd. (株式会社シンテック) |
| Wabo Eelectronic Co.,Ltd. (ワボウ電子株式会社) | Espec Kyushu Co., Ltd. (エスペック九州株式会社) | ALDETE Corporation (株式会社アルデート) |
| Nikon TEC Corporation (株式会社ニコンテック) | Beam Sense Co., Ltd. (株式会社ビームセンス) | Mitsuboshi Diamond Industrial Co.,Ltd. (三星ダイヤモンド工業株式会社) |
| Namiki Precision Jewel Co.,Ltd. (並木精密宝石株式会社) | NAGASE & Co., Ltd. (長瀬産業株式会社) | eInfochips Ltd. |
| Ansoft Corporation (アンソフト・ジャパン株式会社) | Toray Engineering Co.,Ltd. (東レエンジニアリング株式会社) | |

※上記他、インド企業や国内企業数社が出展を検討中です。
※出展内容については、近日中にホームページに更新いたします。

本件に関するお問い合わせ先：
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